

SANYO Semiconductors

DATA SHEET

An ON Semiconductor Company

N-Channel Silicon MOSFET

SFT1440 — General-Purpose Switching Device Applications

Features

• ON-resistance RDS(on)= 6.2Ω (typ.)

· Protection diode in

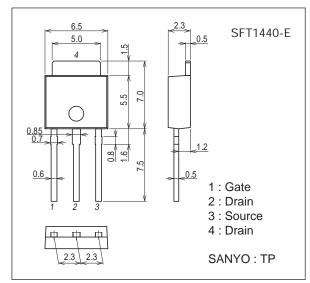
Specifications

Absolute Maximum Ratings at Ta=25°C

	-			
Parameter	Symbol	Conditions	Ratings	Unit
Drain-to-Source Voltage	V _{DSS}		600	V
Gate-to-Source Voltage	V _{GSS}		±30	V
Drain Current (DC)	ID		1.5	А
Drain Current (PW≤10μs)	IDP	PW≤10μs, duty cycle≤1%	6.0	А
Allewskie Daws Diesis sties	D-		1.0	W
Allowable Power Dissipation	PD	Tc=25°C	20	W
Channel Temperature	Tch		150	°C
Storage Temperature	Tstg		-55 to +150	°C

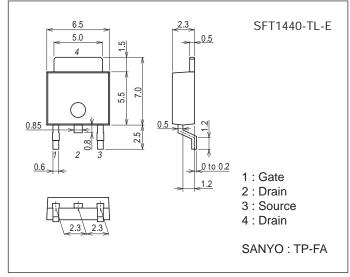
Package Dimensions unit : mm (typ)

7518-004



Package Dimensions unit : mm (typ)

7003-004



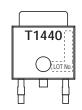
Product & Package Information

• Package : TP

• JEITA, JEDEC : SC-64, TO-251

• Minimum Packing Quantity: 500 pcs./bag

Marking (TP, TP-FA)

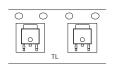


• Package : TP-FA

• JEITA, JEDEC: SC-63, TO-252

• Minimum Packing Quantity: 700 pcs./reel

Packing Type (TP-FA): TL



Electrical Connection (TP, TP-FA)

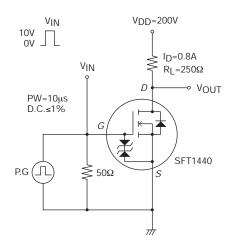
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http://semicon.sanyo.com/en/network

Electrical Characteristics at Ta=25°C

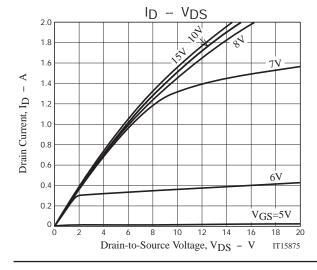
Parameter	Symbol	Conditions	Ratings			Unit	
Parameter	Symbol	Conditions	min	typ	max	UIIIL	
Drain-to-Source Breakdown Voltage	V(BR)DSS	ID=10mA, VGS=0V	600			V	
Zero-Gate Voltage Drain Current	IDSS	V _{DS} =480V, V _{GS} =0V			100	μΑ	
Gate-to-Source Leakage Current	IGSS	VGS=±24V, VDS=0V			±10	μΑ	
Cutoff Voltage	VGS(off)	V _{DS} =10V, I _D =1mA	3.0		5.0	V	
Forward Transfer Admittance	yfs	V _{DS} =10V, I _D =0.8A		1.0		S	
Static Drain-to-Source On-State Resistance	R _{DS} (on)1	I _D =0.8A, V _{GS} =10V		6.2	8.1	Ω	
Input Capacitance	Ciss			130		pF	
Output Capacitance	Coss	V _{DS} =30V, f=1MHz		25		pF	
Reverse Transfer Capacitance	Crss			4.0		pF	
Turn-ON Delay Time	t _d (on)			9.1		ns	
Rise Time	tr	Can appointed Toot Circuit		15		ns	
Turn-OFF Delay Time	t _d (off)	See specified Test Circuit.		18		ns	
Fall Time	tf			19		ns	
Total Gate Charge	Qg			6.3		nC	
Gate-to-Source Charge	Qgs	V _{DS} =300V, V _{GS} =10V, I _D =1.5A		1.4		nC	
Gate-to-Drain "Miller" Charge	Qgd			3.6		nC	
Diode Forward Voltage	V _{SD}	I _S =1.5A, V _{GS} =0V		0.85	1.2	V	

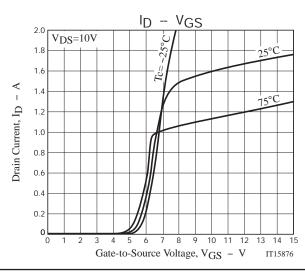
Switching Time Test Circuit

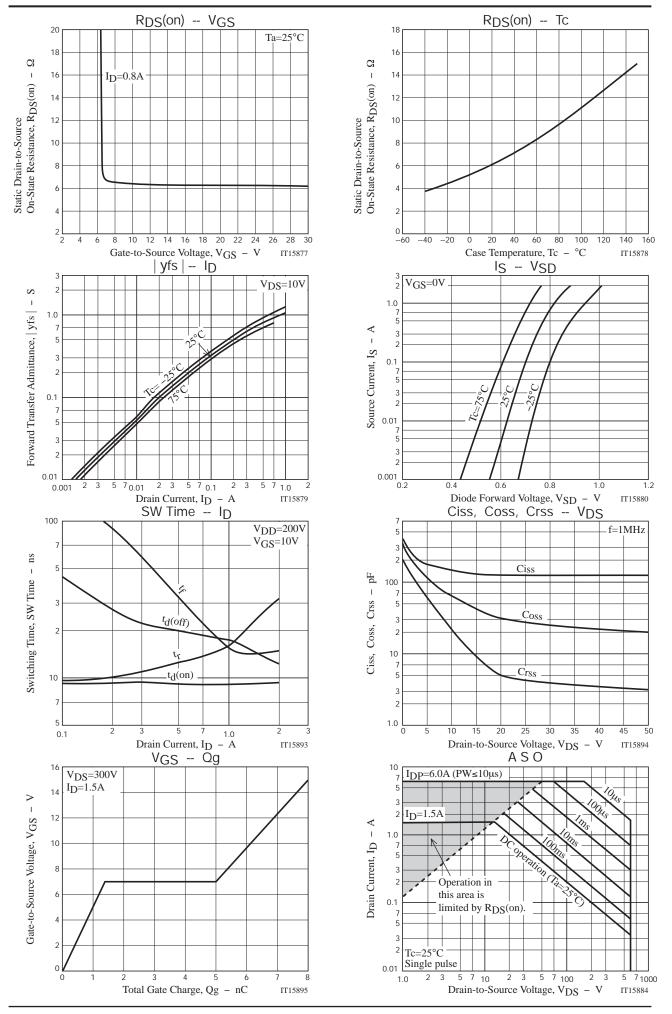


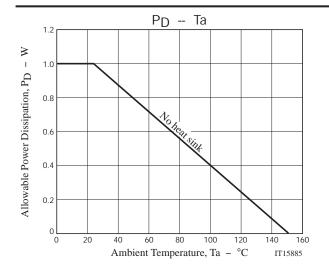
Ordering Information

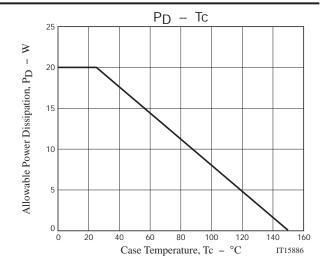
Device	Package	Shipping	memo
SFT1440-E	TP	500pcs./bag	Pb Free
SFT1440-TL-E	TP-FA	700pcs./reel	Pb Flee









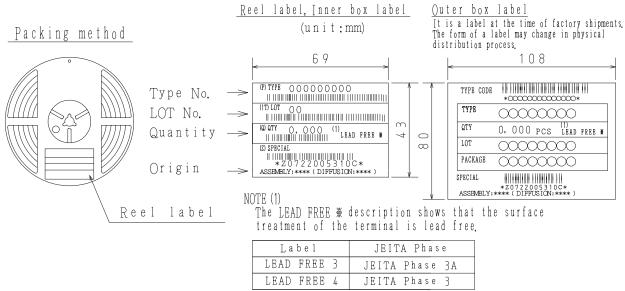


Taping Specification

SFT1440-TL-E

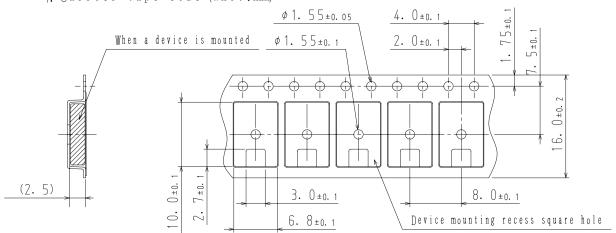
Packing Format

Package Name	Carrier Tape	Maximum Number of devices contained (pcs)			Packing	format
	Туре	Reel	Inner box	Outer box	Inner BOX (C-1)	Outer BOX (A-7)
TP-FA	TP	700	2, 100	12, 600	3 reels contained	6 inner boxes contained
					Dimensions:mm (external)	Dimensions:mm (external)
					183×72×185	440×195×210

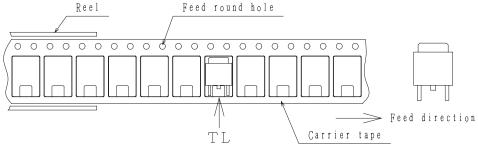


Taping configuration

1. Carrier tape size (unit:mm)



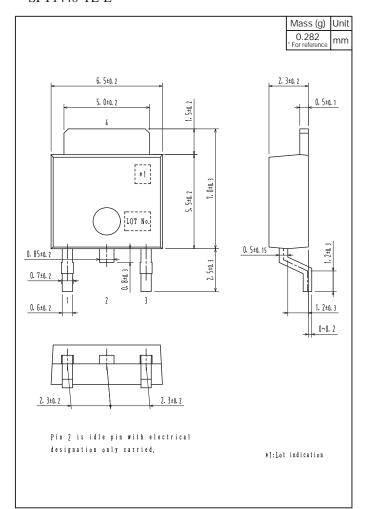
7. Device placement direction

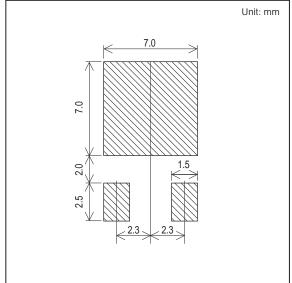


Those with one electrode terminal on the feed hole side·····TL

Outline Drawing SFT1440-TL-E

Land Pattern Example





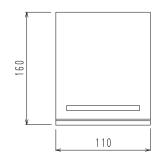
Bag Packing Specification

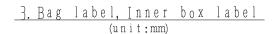
SFT1440-E

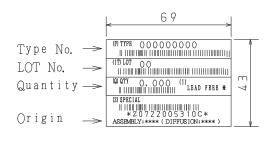
1. Packing Format

Package Name		Maximum Number of devices contained (pcs)				
I worked Mamo	Bag	Inner box	Outer box			
T D		B-1	A-1	A-2		
TP	500	10,000	50,000	30,000		
		Packing fo	rmat (Dimensions:m	m (external))		
		Inner box	Outer box			
		B-1	A-1	A-2		
4 4 5 × 2 2 5 × 5 5		445×225×55	470×250×300	470×250×190		

2. Bag dimensions (unit:mm)





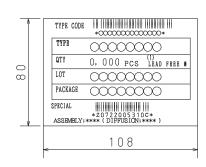


4. Outer box label (unit:mm)

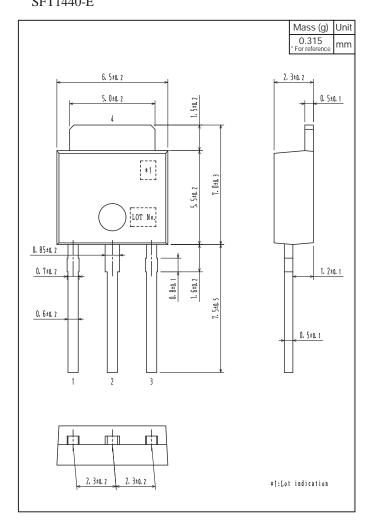
It is a label at the time of factory shipments, The form of a label may change in physical distribution process,



Label			JEITA Phase
LEAD	FREE	3	JEITA Phase 3A
LEAD	FREE	4	JEITA Phase 3



Outline Drawing SFT1440-E



Note on usage: Since the SFT1440 is a MOSFET product, please avoid using this device in the vicinity of highly charged objects.

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